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INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(Not for submission under 37 CFR 1.99)</i>	Application Number		10551745
	Filing Date		2007-03-19
	First Named Inventor		Edmund Riedl
	Art Unit		
	Examiner Name		
	Attorney Docket Number		I431.131.101/FIN421PCT/US

U.S.PATENTS						
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CN	1	20050048758		2005-03-03	Hosseini et al.	
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CN	1	2930779	DE		1980-02-07	Tokyo Shibaura Denki K.K.,	<input type="checkbox"/>
CN	2	54150076	JP		1979-11-24	Omron Tateisi Electronics Co.	<input type="checkbox"/>

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CN	3	2000294444	JP		2000-10-20	Sumitomo Electric Industries		<input type="checkbox"/>
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